

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HITACHI, LTD.	03/09/2009
RECEIVING PARTY DATA	
Name:	Renesas Technology Corp.
Street Address:	6-2, Otemachi 2-chome
Internal Address:	Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11331220
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Total Attachments: 1 source=Assignment#page 1.tif	

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REEL: 022774 FRAME: 0406

ASSIGNMENT

WHEREAS, **HITACHI, LTD.** is the owner of all of the entire interest in and to the following patent application, and the invention claimed therein:

U.S. Patent Application Serial No 11/331,220 file on January 13, 2006,
for invention entitled "Pb-free solder-connected structure and electronic device "
by assignment.

WHEREAS, **Renesas Technology Corp.**, a corporation organized under the laws of Japan of **6-2, Otemachi 2-chome, Chiyoda-ku, Tokyo, Japan**, desirous of acquiring all of the right, title and interest of **HITACHI, LTD.** in and to the aforesaid patent application and the invention claimed therein:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, **HITACHI, LTD.** has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over unto **Renesas Technology Corp.** its entire right, title and interest in and to the aforesaid patent application, its entire right, title and interest in the said invention, said application for Letters Patent, and all divisions, continuations and extensions thereof, and any Letters Patent that may be granted thereon, and any reissue or reissues of Letters Patent which may be granted, the same to be held and enjoyed by said **Renesas Technology Corp.** for their own use and enjoyment, and for the use and enjoyment of their successors, assigns, or other legal representatives, to the end of the term for which said Letters Patents of the United States are granted or reissued as fully and entirely as the same would have been held and enjoyed by the said **Hitachi, Ltd.**, if this assignment and sale had not been made.

AND **HITACHI, LTD.** warrants that it has full right to convey its entire interest herein assigned, and that it has not executed, and will not execute, any agreement in conflict with this assignment.

IN TESTIMONY WHEREOF, **HITACHI, LTD.**, has caused these presence to be signed by its officer(s) thereunto duly authorized this 9th day of March, 2009.

HITACHI, LTD.


Name: Hiroyuki HIRAYAMA

Title: Corporate Officer
Managing Director
Intellectual Property Group
(Authorized Signing Officer)

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